

# IGBT XPT Module

## H Bridge

$$V_{CES} = 1200 \text{ V}$$

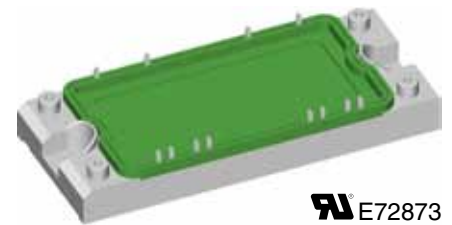
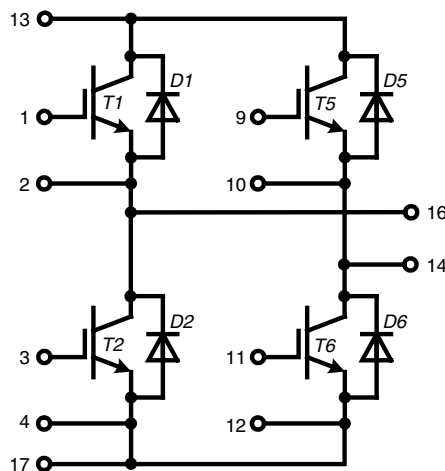
$$I_{C25} = 85 \text{ A}$$

$$V_{CE(sat)} = 1.8 \text{ V}$$

Preliminary data

**Part name** (Marking on product)

MIXA 61H1200ED



### Features:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10  $\mu$ sec.
  - very low gate charge
  - square RBSOA @ 3x  $I_C$
  - low EMI
- Thin wafer technology combined with the XPT design results in a competitive low  $V_{CE(sat)}$
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

### Application:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies

### Package:

- "E2-Pack" standard outline
- Insulated copper base plate
- Soldering pins for PCB mounting

**Output Inverter T1 - T6**

Symbol	Definitions	Conditions	Ratings				
			min.	typ.	max.	Unit	
$V_{CES}$	collector emitter voltage		$T_{VJ} = 25^{\circ}\text{C}$		1200	V	
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V	
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V	
$I_{C25}$	collector current		$T_C = 25^{\circ}\text{C}$		85	A	
$I_{C80}$			$T_C = 80^{\circ}\text{C}$		60	A	
$P_{tot}$	total power dissipation		$T_C = 25^{\circ}\text{C}$		290	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 55\text{ A}; V_{GE} = 15\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	1.8 2.1	2.1	V V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 2\text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^{\circ}\text{C}$	5.4	6.0	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		0.5	0.2	mA mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 50\text{ A}$			165	nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{ V}; I_C = 50\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 15\ \Omega$	$T_{VJ} = 125^{\circ}\text{C}$		70	ns	
$t_r$	current rise time				40	ns	
$t_{d(off)}$	turn-off delay time				250	ns	
$t_f$	current fall time				100	ns	
$E_{on}$	turn-on energy per pulse				4.5	mJ	
$E_{off}$	turn-off energy per pulse				5.5	mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15\text{ V}; R_G = 15\ \Omega;$	$T_{VJ} = 125^{\circ}\text{C}$ $V_{CEK} = 1200\text{ V}$		150	A	
<b>SCSOA</b>	short circuit safe operating area		$T_{VJ} = 125^{\circ}\text{C}$		10	$\mu\text{s}$	
$t_{SC}$	short circuit duration	$V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V};$			200	A	
$I_{SC}$	short circuit current	$R_G = 15\ \Omega;$ non-repetitive					
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			0.43	K/W	

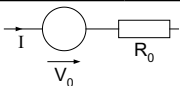
**Output Inverter D1 - D6**

Symbol	Definitions	Conditions	Ratings			
			min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^{\circ}\text{C}$		1200	V
$I_{F25}$	forward current		$T_C = 25^{\circ}\text{C}$		85	A
$I_{F80}$			$T_C = 80^{\circ}\text{C}$		57	A
$V_F$	forward voltage	$I_F = 60\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	1.95 1.95	2.2	V V
$Q_{rr}$	reverse recovery charge	$V_R = 600\text{ V}$ $di_f/dt = -1200\text{ A}/\mu\text{s}$ $I_F = 60\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 125^{\circ}\text{C}$		8	$\mu\text{C}$
$I_{RM}$	max. reverse recovery current				60	A
$t_{rr}$	reverse recovery time				350	ns
$E_{rec}$	reverse recovery energy				2.5	mJ
$R_{thJC}$	thermal resistance junction to case	(per diode)			0.6	K/W

 $T_C = 25^{\circ}\text{C}$  unless otherwise stated

**Module**

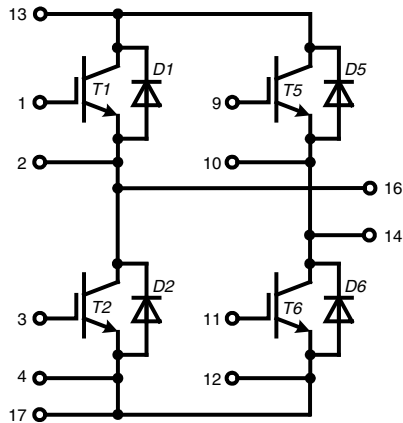
Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$T_{VJ}$	operating temperature		-40		125	°C
$T_{VJM}$	max. virtual junction temperature				150	°C
$T_{stg}$	storage temperature		-40		125	°C
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			3000	V~
<b>CTI</b>	comparative tracking index				-	
$M_d$	mounting torque (M5)		3		6	Nm
$d_s$	creep distance on surface		6			mm
$d_A$	strike distance through air		6			mm
$R_{pin-chip}$	resistance pin to chip			5		mΩ
$R_{thCH}$	thermal resistance case to heatsink	with heatsink compound		0.02		K/W
<b>Weight</b>				180		g

**Equivalent Circuits for Simulation**


Symbol	Definitions	Conditions	min.	Ratings		Unit
				typ.	max.	
$V_0$ $R_0$	IGBT	T1 - T6	$T_{VJ} = 150^\circ\text{C}$	1.1 25.1		V mΩ
$V_0$ $R_0$	free wheeling diode	D1 - D6	$T_{VJ} = 150^\circ\text{C}$	1.22 12.99		V mΩ

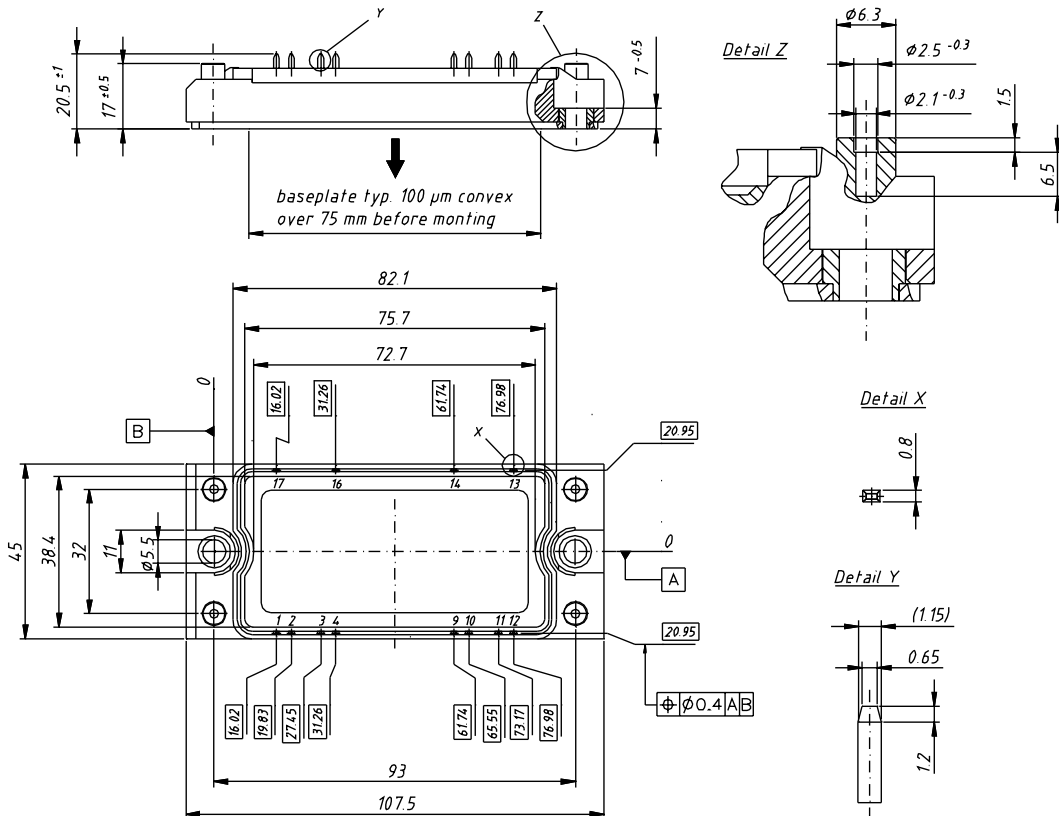
 $T_C = 25^\circ\text{C}$  unless otherwise stated

### Circuit Diagram

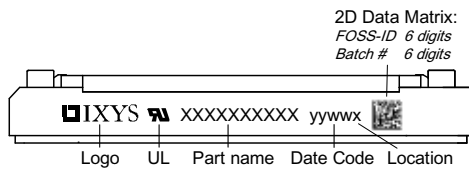


### Outline Drawing

Dimensions in mm (1 mm = 0.0394")



### Product Marking



### Part number

- M = Module
- I = IGBT
- X = XPT
- A = standard
- 61 = Current Rating [A]
- H = H~ Bridge
- 1200 = Reverse Voltage [V]
- ED = E2-Pack

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MIXA61H1200ED	MIXA61H1200ED	Box	6	511060

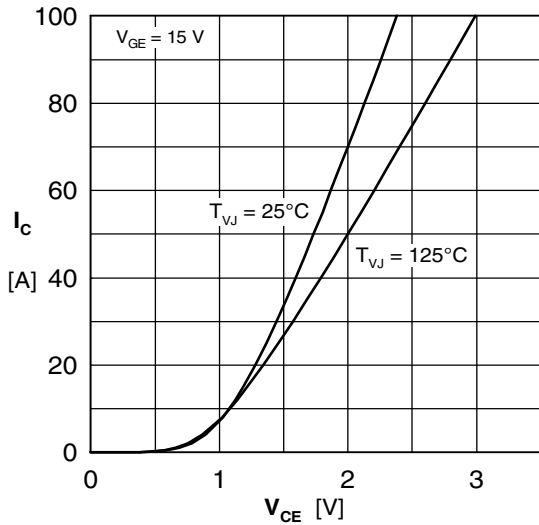
**Inverter T1 - T6**


Fig. 1 Typ. output characteristics

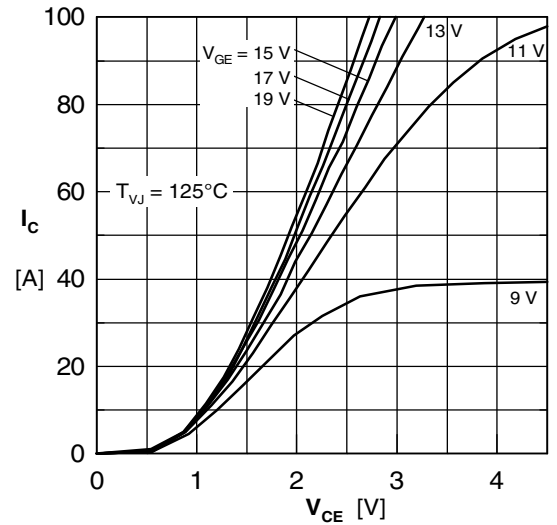


Fig. 2 Typ. output characteristics

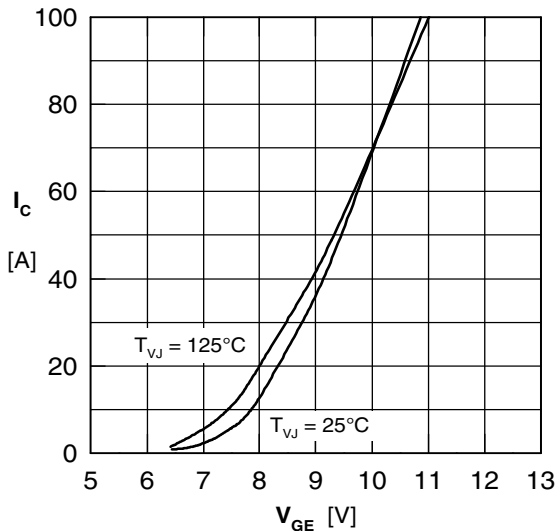


Fig. 3 Typ. transfer characteristics

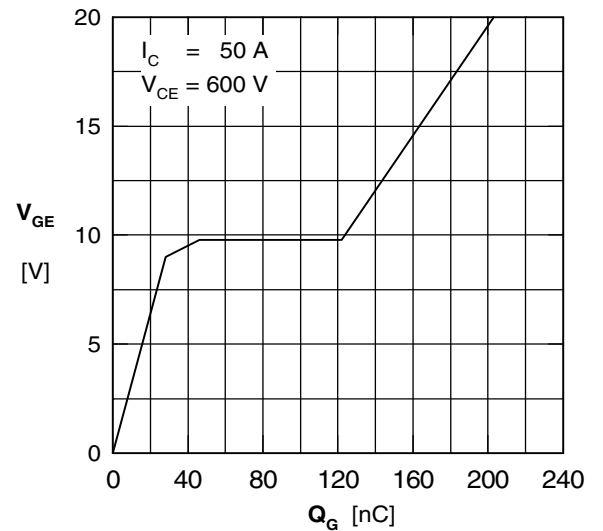


Fig. 4 Typ. turn-on gate charge

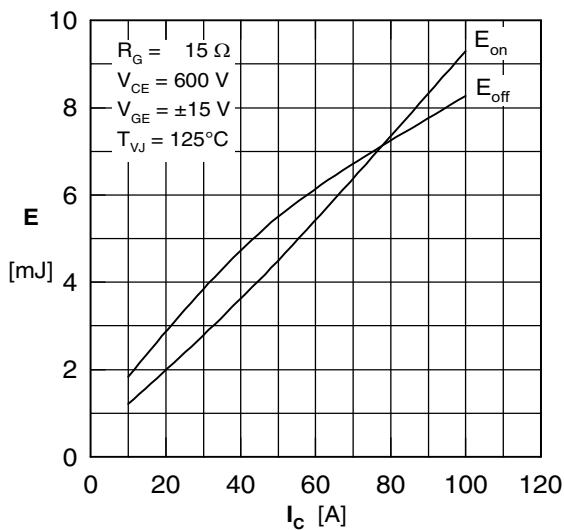


Fig. 5 Typ. switching energy vs. collector current

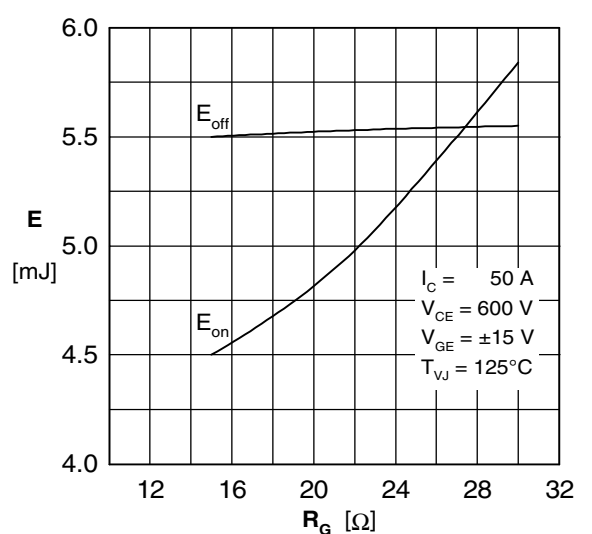


Fig. 6 Typ. switching energy vs. gate resistance

## Inverter D1 - D6

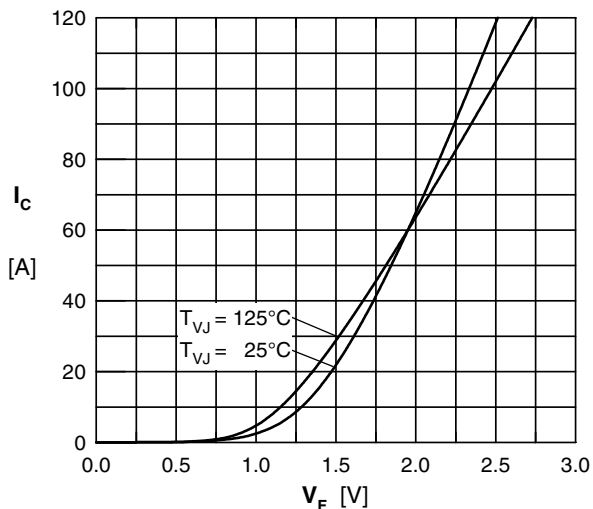


Fig. 7 Typ. Forward current versus  $V_F$

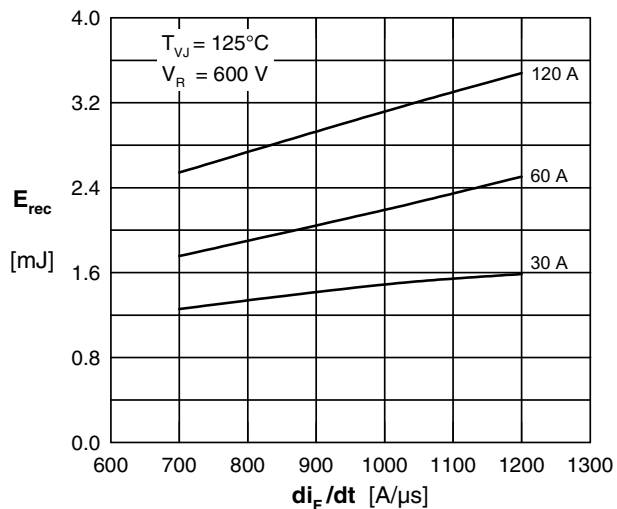


Fig. 8 Typ. recovery energy  $E_{rec}$  versus  $di/dt$

	IGBT		FRD	
	$R_i$	$\tau_i$	$R_i$	$\tau_i$
1	0.1	0.0025	0.137	0.0025
2	0.05	0.03	0.1	0.03
3	0.21	0.03	0.233	0.03
4	0.07	0.08	0.13	0.08

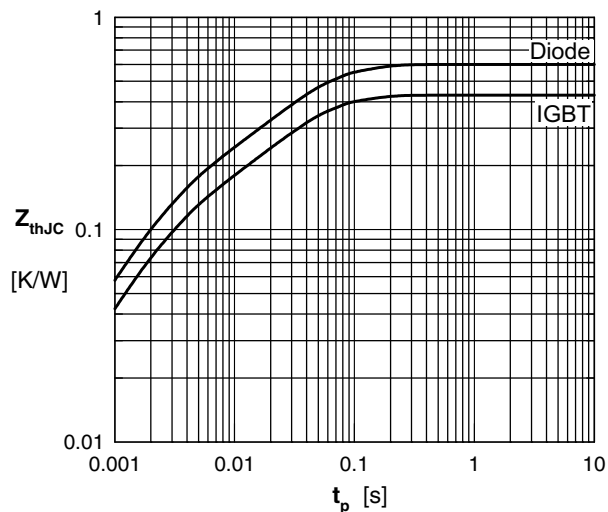


Fig. 9 Typ. transient thermal impedance

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[FD401R17KF6C\\_B2](#) [FD-DF80R12W1H3\\_B52](#) [FF200R06YE3](#) [FF300R12KE4\\_E](#) [FF450R12ME4P](#) [FF600R12IP4V](#) [FP10R06W1E3\\_B11](#)  
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[F475R07W1H3B11ABOMA1](#) [FD1400R12IP4D](#) [FD200R12PT4\\_B6](#) [FD800R33KF2C-K](#) [FF1200R17KP4\\_B2](#) [FF300R17KE3\\_S4](#)  
[FF300R17ME4\\_B11](#) [FF401R17KF6C\\_B2](#) [FF650R17IE4D\\_B2](#) [FF900R12IP4D](#) [FF900R12IP4DV](#) [STGIF7CH60TS-L](#) [FP50R07N2E4\\_B11](#)  
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